PRODUCT :	TFT TOUCH MODULE	
MODULE NO. :		
SUPPLIER:		
DATE:		

# **SPECIFICATION**

Revision: 0.0

This module uses ROHS material

This specification may change without prior notice in order to improve performance or quality. Please contact WKS R&D department for updated specification and product status before design for this product or release of this order.

WRITTEN BY	CHECKED BY	APPROVED BY

# **REVISION RECORD**

REV NO.	REV DATE	CONTENTS	REMARKS
0.0	2022-10-22	First release	Preliminary

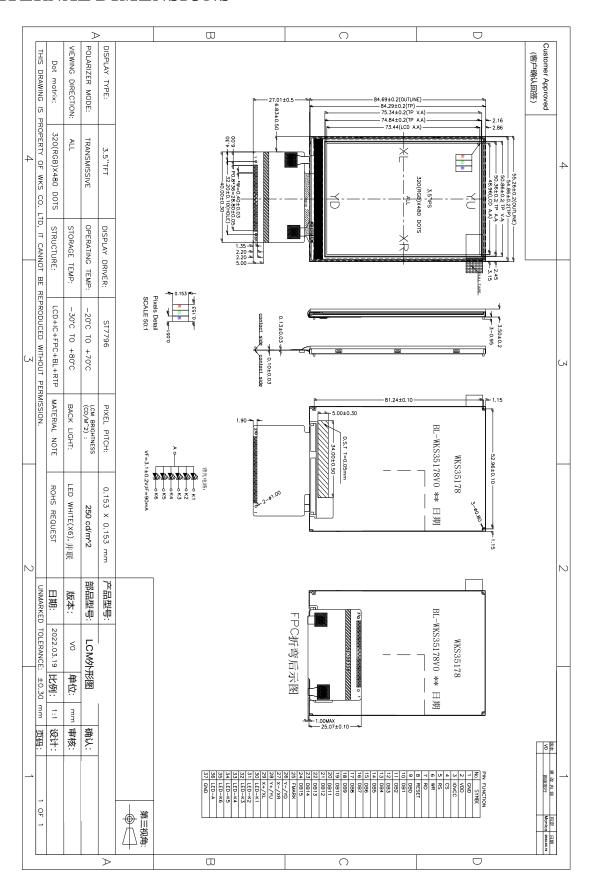
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# 1. GENERAL INFORMATION

Item of general information	Contents	Unit
LCD Display Size (Diagonal)	3.5	inch
LCD Display Type	TFT/TRANSMISSIVE	-
LCD Display Mode	Normally Black	-
Recommended Viewing Direction	ALL	-
Gray inversion Direction	-	-
Module size $(W \times H \times T)$	55.26×84.69×3.50	mm
Active area (W×H)	48.96×73.44	mm
Number of pixels (Resolution)	320RGB×480	pixel
Pixel pitch (W×H)	0.153×0.153	mm
Color Pixel Arrangement	RGB Stripe	-
LCD Driver IC	ST7796	-
Interface Type	8080 16bit Parallel interface	-
Color Numbers	65K	-
Backlight Type	White LED	-

#### 2, EXTERNAL DIMENSIONS



#### 3, ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
LCD mark walk as a	VCI	-0.3	5.5	V
LCD supply voltage	IOVCC	-0.3	5.5	V
Operating temperature	Тор	-20	70	$^{\circ}\!C$
Storage temperature	Tst	-30	80	$^{\circ}\!C$
Humidity	RH	-	90%(Max 60°C)	RH

Note: Absolute maximum ratings mean the product can withstand short-term, not more than 120 hours. If the product is a long time to withstand these conditions, the life time would be shorter.

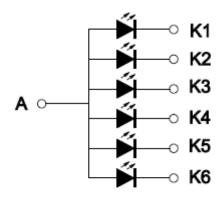
# 4, ELECTRICAL CHARACTERISTICS(DC CHARACTERISTICS)

Parameter of DC characteristics	Symbol	Min.	Тур.	Max.	Unit
Analog operating voltage	VCI	2.3	2.8	3.3	V
I/O operating voltage	IOVCC	1.65	1.8	3.3	V
Input voltage 'H' level	VIH	0.7*IOVCC	-	IOVCC	V
Input voltage 'L' level	VIL	VSS	-	0.2*IOVCC	V
Output voltage 'H' level	VOH	0.8*IOVCC	-	IOVCC	V
Output voltage 'L' level	VOL	VSS	-	0.2IOVCC	V

#### 5, BACKLIGHT CHARACTERISTICS

Item of backlight characteristics	Symbol	Min.	Тур.	Max.	Unit	Remark
Forward voltage	Vf	2.9	3.1	3.3	V	Note1
Forward Current	If	-	90	-	mA	
Number of LED	-	-	6	-	Piece	-
LED Connection mode	P/S	-	Parallel	-	-	-
Lifetime of LED	-	-	10000	-	hour	Note2

- Note1: The LED Supply Voltage is defined by the number of LED at Ta=25°C and If=90mA.
- Note2: The LED lifetime define as the estimated time to 50% degradation of initial luminous. The LED lifetime could be decreased if operating If is larger than 120mA.
- Backlight circuit :



#### 6, ELECTRO-OPTICAL CHARACTERISTICS

Item o electro-op character	otical	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response	time	Tr+Tf	$\theta = 0$	-	25	35	ms	FIG 1.	4
Contrast I	Ratio	CR	$\emptyset=0$ $\emptyset=0$	-	800	-	-	FIG 2.	1
Luminance un	iformity	$\delta$ WHITE	Ta=25°C	-	80	-	%	FIG 2.	3
Surface Lum	inance	Lv		-	250	-	cd/m2	FIG 2.	2
	White	White x	-	-	0.304	-		FIG 2.	
	wniie	White y		-	0.332	-			
	Red	Red x		-	0.655	-			5
CIE(x, y)	кеа	Red y	$\theta=0$	-	0.317	-			
chromaticity	C	Green x	Ø=0 Ta=25°C	-	0.262	-			
	Green	Green y	14-25	-	0.568	-			
	D1	Blue x		_	0.137	-			
	Blue	Blue y		-	0.085	-			
	Ø=90(1	2 o'clock)		-	85	-	deg		
Viewing	Ø=270(	(6 o'clock)	GD . 10	-	85	-	deg	EIC 2	
angle range	Ø=0(3	o'clock)	<i>CR</i> ≥ 10	-	85	-	deg	FIG 3.	6
	Ø=180(	(9 o'clock)		-	85	-	deg		
NTSC ratio			-	-	60	-	%		-

*Note 1.* Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.

 $Contrast\ Ratio(CR) = \frac{Average\ Surface\ Luminance\ with\ all\ white\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}{Average\ Surface\ Luminance\ with\ all\ black\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}$ 

**Note 2.** Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv=Average Surface Luminance with all white pixels (P1,P2,P3,P4,P5,P6,P7,P8,P9)

*Note 3.* The uniformity in surface luminance  $(\delta WHITE)$  is determined by measuring

luminance at each test position 1 through 9, and then dividing the maximum luminance of 9 points luminance by minimum luminance of 9 points luminance. For more information see FIG 2.

$$\delta \text{WHITE} = \frac{\textit{Minimum Surface Luminance with all white pixels}(P1, P2, P3, P4, P5, P6, P7, P8, P9)}{\textit{Maximum Surface Luminance with all white pixels}(P1, P2, P3, P4, P5, P6, P7, P8, P9)}$$

**Note 4.** Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1.

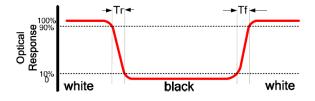
**Note 5.** CIE (x, y) chromaticity, The x,y value is determined by screen active area position 5. For more information see FIG 2.

**Note 6.** Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

**Note 8.** For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

### FIG.1. The definition of Response Time



# FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity,

# CIE(x, y) chromaticity

A: H/6; B: V/6;

H,V: Active Area(AA) size

Measurement instrument: BM-7; Light spot size=5mm, 350mm distance from the LCD surface to detector lens.

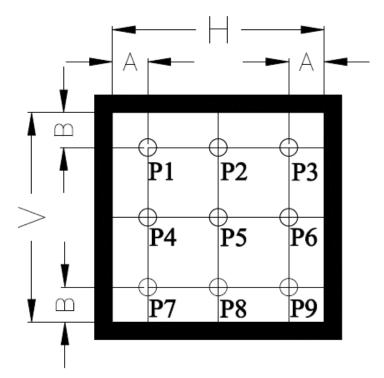
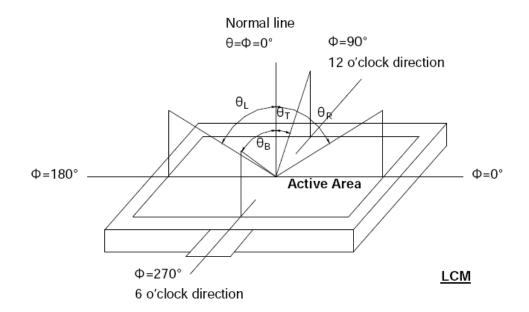


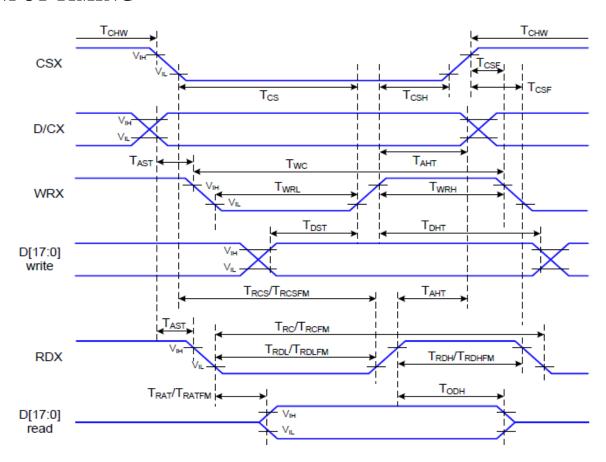
FIG.3. The definition of viewing angle



# 7. INTERFACE DESCRIPTION

NO.	Symbol	I/O	DESCRIPTION
1	GND	Power supply	Power ground
2	VCI	Power supply	Power supply to the liquid crystal power supply analog circuit.  VCI=2.3~3.3V
3	IOVCC	Power supply	Power supply to the I/O.IOVCC=1.65~3.3V
4	CS	I	Chip select
5	RS	I	Data/Command select
6	WR	I	Write strobe signal
7	RD	I	Read strobe signal
8	RESET	I	LCD RESET signal, Low is active
9~24	D0~D15	I/O	Data bus(D0:LSB; D15:MSB)
25	FMARK (TE)	0	Frame head pulse signal. Utilize this signal when synchronizing RAM data write operations. If not used, please open this pin.
26	YD	I	RTP pin
27	XR	I	RTP pin
28	YU	I	RTP pin
29	XL	I	RTP pin
30	LED-K1	Power supply	Backlight Cathode
31	LED-K2	Power supply	Backlight Cathode
32	LED-K3	Power supply	Backlight Cathode
33	LED-K4	Power supply	Backlight Cathode
34	LED-K5	Power supply	Backlight Cathode
35	LED-K6	Power supply	Backlight Cathode
36	LED-A	Power supply	Backlight Anode
37	GND	Power supply	Power ground

# 8. INPUT TIMING



80-System Bus Interface Timing

Signal	Symbol	Parameter	Min	Max	Unit	Description
T <sub>AST</sub>		Address setup time	0		ns	
D/CX	T <sub>AHT</sub>	Address hold time (Write/Read)	10		ns	-
	Тснw	Chip select "H" pulse width	0		ns	
	Tcs	Chip select setup time (Write)	15		ns	
CSX T <sub>RCS</sub>		Chip select setup time (Read ID)	45		ns	
CSA	Тесь	Chip select setup time (Read FM)	355		ns	_
	T <sub>CSF</sub>	Chip select wait time (Write/Read)	10		ns	
Тсян		Chip select hold time	10		ns	
WRX	Twc	Write cycle	66		ns	
WKX	T <sub>WRH</sub>	Control pulse "H" duration	15		ns	

	T <sub>WRL</sub>	Control pulse "L" duration	15		ns	
	T <sub>RC</sub> Read cycle (ID)		160		ns	
RDX (ID)	Trdh	Control pulse "H" duration (ID)	90		ns	When read ID data
	$T_{RDL}$	Control pulse "L" duration (ID)	45		ns	
RDX	Тесьм	Read cycle (FM)	450		ns	When read from
(FM)	TRDHFM	Control pulse "H" duration (FM)	90		ns	frame memory
T <sub>RDLFM</sub>		Control pulse "L" duration (FM)	355		ns	name memory
	Трят	Data setup time	10		ns	
	$T_DHT$	Data hold time	10		ns	
D[17:0]	T <sub>RAT</sub>	Read access time (ID)	-	40	ns	For CL=30pF
	Ткатем	Read access time (FM)	-	340	ns	
	T <sub>ODH</sub>	Output disable time	20	80	ns	

#### 9, RELIABILITY TEST CONDITIONS

No.	. Test Item Test Condition	
1	High Temperature Storage	80°C/120 hours
2	Low Temperature Storage	-30°C/120 hours
3	High Temperature Operating	70°C/120 hours
4	Low Temperature Operating	-20°C/120 hours
5	Temperature Cycle Storage	-20°C(30min.)~25(5min.)~70°C(30min.)×10cycles

#### A. Inspection after test:

Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:

- ➤ Air bubble in the LCD;
- > Sealleak;
- ➤ Non-display;
- Missing segments;
- ➤ Glass crack;
- Current is twice higher than initial value.

#### B, Remark:

- The test samples should be applied to only one test item.
- ➤ Sample size for each test item is 5~10pcs.
- Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

#### 10 INSPECTION CRITERION

This specification is made to be used as the standard of acceptance/rejection criteria for TFT-LCD/IPS TFT-LCD module product, and this specification is applicable only in the case that the size of module equal to or exceed than 3.5 inch.

#### 10.1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993,normal level 2 and based on:

Major defect: AQL 0.65

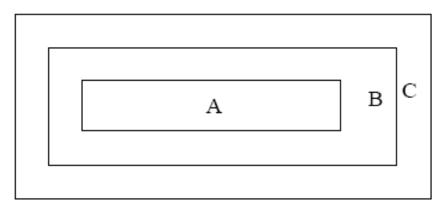
Minor defect: AQL 1.5

#### 10.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45 °against perpendicular line. (Normal temperature 20~25 °C and normal humidity 60  $\pm 15\%$ RH)

# 10.3 Definition of Inspection Item.

# A. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (Zone A + Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

# B. Definition of some visual defect

	Because of losing all or part function, bad pixel dots appear bright and the					
Bright dot	size is more than 50% of one dot in which LCD panel is displaying under					
	black pattern.					
Dark dot	Dots appear dark and unchanged in size in which LCD panel is displaying					
	under pure red, green, blue picture, or pure whiter picture.					

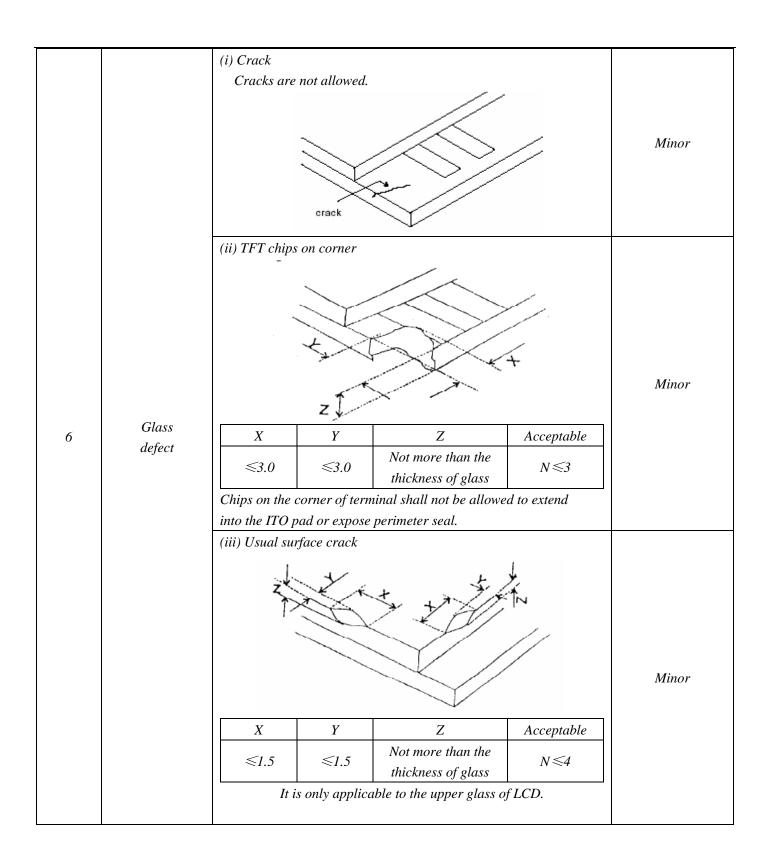
# 10.4 Major Defect

Item No.	Items to be inspected	Inspection standard	Classification of defects
1	Functional defects	1) No display 2) Display abnormally 3) Missing vertical, horizontal segment 4) Short circuit 5) Excess power consumption 6)Backlight no lighting, flickering and abnormal lighting	major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	

# 10.5 Minor Defect

Item No.	Items to be	Inspection standard						Classification
140.	inspected							of defects
		Zo	ne		Accepto	able Qty		
				A+B			=	
				3.5~			С	
		Bright pixel		1	2	3		
	Bright dot	Dark pixel dot		4	4	4	Aca	
1	/dark dot	2bright dots a		0		0	Acceptable	Minor
	defect	2dark dots ac		0	0	0	able	
	v	Total bright a dots	nd dark	5	6	7	,,	
		Note: Minimum distance between defective dots is more than 5mm; Pixel dots' function is normal, but bright dots caused by foreign material and other reasons are judged by the dot defect of 5.2.						
		Zone Acceptable Qty						
	Dot defect			A+B				
		Size(mm)	3.5"	~7"	7~10.1"	>10.1"	С	
		Φ≤0.2	Ассер	otable	Acceptable	Acceptable	Acc	
2		0.2 < Ф ≤ 0.5	2	1	5	6	Acceptable	Minor
		Φ>0.5	(	)	0	0	le	
		Note: 1. Minimum distance between defective dots is more than 5 mm; 2. The quantity of defect is zero in operating condition.						
3	Linear defect	Zone			Acceptable	Qty		
		Size (mm)		A+B				
		Length Width	a 3.5"	~7"	7~10.1"	>10.1"	С	Minor
		Ignore W≤0.0	5 Accep	table	Acceptable	Acceptable	Ac	WINOI
			4	!	5	6	Acceptable	
		L>5.0 $W>0.$	1 0	)	0	0	le	

		Т						<del></del>	
		5.4.1 Pola	ırizer Posii	tion					
		( i) Shiftin							
		dimension	ı.						
		( ii ) Incor	nplete cov	ering of the vie	ewing area du	e to shifting is	s not		
		allowed.	•		Ü	v c			
			on polariz	er					
			5.4.2 Dirt on polarizer  Dirt which can be wiped easily should be acceptable.						
			5.4.3 Polarizer Dent & Air bubble						
		5.4.5 F 010							
		Zone			Acceptable	Qty			
				A+B					
		Size(mm	)	3.5"~7"	7~10.1"	>10.1"	С		
		$\Phi$ :	<i>≤</i> 0.2	Acceptable	Acceptable	Acceptable	Acc		
		0.2 <	<i>Φ</i> ≤0.5	4	5	6	Acceptable		
4	Polarizer	$\Phi_{\lambda}$	>0.5	0	0	0	ble	Minor	
	defect	5.4.4 Pol	arizer scr	atch					
				scratch can b	e seen after	cover assemi	bling		
		-					_		
			or in the operating condition, judge by the linear defect of 5.3.						
			(ii) If the polarizer scratch can be seen only in non-operating						
		Condition	condition or some special angle, judge by the following:						
		Zone		Acceptable Qty					
		Size (mm)		A+B					
		Length	Width	<i>3.5"∼7"</i>	7~10.1"	>10.1"	С		
		Ignore	<i>W</i> ≤0.05	Acceptable	Acceptable	Acceptable	A		
		1.0 < L	0.05 <	_	_	-	ccep		
		$\left  \begin{array}{c c} \leq 5.0 & W \leq 0.20 \end{array} \right  \qquad \left  \begin{array}{c c} 4 & 5 \end{array} \right $	5	5 6	Acceptable				
		L>5.0	W>0.2	0	0	0	le		
5	MURA	Using							
	White/Black dot (MURA)	Visible under: ND3%; $D \le 0.15$ mm, Acceptable; $0.15$ mm $< D \le 0.5$ mm, $N \le 4$ ; $D>0.5$ mm, Not allowable.						Minor	



# 10.6 Module Cosmetic Criteria

Item No.	Items to be inspected	Inspection Standard	Classification of defects	
1	Difference in Spec.	Not allowable	Major	
2	Pattern peeling	No substrate pattern peeling and floating	Major	
3		No soldering missing	Major	
	Soldering defects	No soldering bridge	Major	
		No cold soldering	Minor	
4	Resist flaw on PCB	Visible copper foil ( $\Phi$ 0.5 mm or more) on substrate pattern is not allowed	Minor	
5	FPC gold finger	No dirt, breaking, oxidation lead to black	Major	
6	Backlight plastic frame	No deformation, crack, breaking, backlight positioning column breaking, obvious nick.	Minor	
7	Marking printing effect	No dark marking, incomplete, deformation lead to unable to judge	Minor	
8	Accretion of metallic Foreign matter	No accretion of metallic foreign matter (Not exceed $\Phi 0.2$ mm)	Minor	
9	Stain	No stain to spoil cosmetic badly	Minor	
10	Plate discoloring	No plate fading, rusting and discoloring	Minor	
	1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.	Minor	
	1. Leau paris	b. Components side(In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor	
	2. Flat packages	Either 'Toe'(A) or 'Seal'(B)of the lead to be covered by "Filet". Lead form to be assume over Solder.	Minor	
11	3. Chips	Minor		
	4. Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad $h \ge 0.13$ mm. The diameter of solder ball $d \le 0.15$ mm.	Minor	
		b. The quantity of solder balls or solder splashes isn't beyond 5 in 600 mm2.	Minor	
		c. Solder balls/Solder splashes do not violate minimum electrical clearance.	Major	